

V_{DSS}	1200V
$R_{DS(on)}$ (Typ.)	80mΩ
I_D	40A
P_D	262W

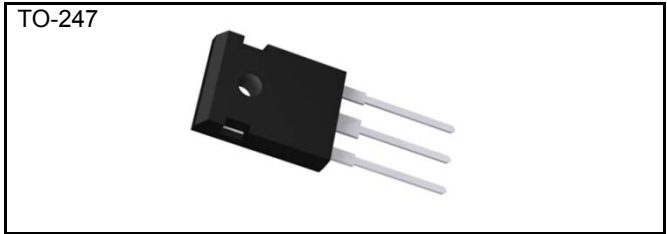
●Features

- 1) Low on-resistance
- 2) Fast switching speed
- 3) Fast reverse recovery
- 4) Easy to parallel
- 5) Simple to drive
- 6) Pb-free lead plating ; RoHS compliant

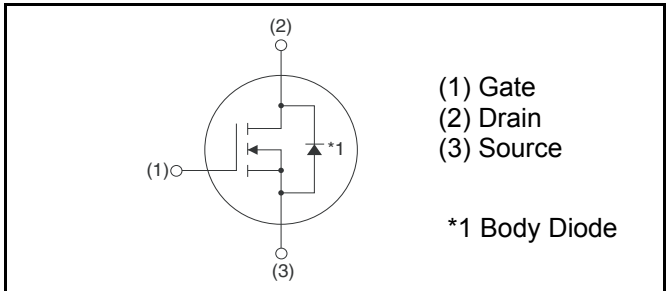
●Application

- Solar inverters
- DC/DC converters
- Induction heating
- Motor drives

●Outline



●Inner circuit



●Packaging specifications

Type	Packing	Tube
	Reel size (mm)	-
	Tape width (mm)	-
	Basic ordering unit (pcs)	30
	Taping code	-
	Marking	SCT2080KE

●Absolute maximum ratings ($T_a = 25^\circ\text{C}$)

Parameter	Symbol	Value	Unit	
Drain - Source voltage	V_{DSS}	1200	V	
Continuous drain current	$T_c = 25^\circ\text{C}$	I_D^{*1}	40	A
	$T_c = 100^\circ\text{C}$	I_D^{*1}	28	A
Pulsed drain current	$I_{D,pulse}^{*2}$	80	A	
Gate - Source voltage	V_{GSS}	-6 to 22	V	
Power dissipation ($T_c = 25^\circ\text{C}$)	P_D	262	W	
Junction temperature	T_j	175	$^\circ\text{C}$	
Range of storage temperature	T_{stg}	-55 to +175	$^\circ\text{C}$	

●Thermal resistance

Parameter	Symbol	Values			Unit
		Min.	Typ.	Max.	
Thermal resistance, junction - case	R_{thJC}	-	0.44	0.57	°C/W
Thermal resistance, junction - ambient	R_{thJA}	-	-	50	°C/W
Soldering temperature, wavesoldering for 10s	T_{sold}	-	-	265	°C

●Electrical characteristics ($T_a = 25^\circ\text{C}$)

Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Drain - Source breakdown voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 1mA$	1200	-	-	V
Zero gate voltage drain current	I_{DSS}	$V_{DS} = 1200V, V_{GS} = 0V$	-	1	10	μA
		$T_j = 150^\circ\text{C}$	-	2	-	
Gate - Source leakage current	I_{GSS+}	$V_{GS} = +22V, V_{DS} = 0V$	-	-	100	nA
Gate - Source leakage current	I_{GSS-}	$V_{GS} = -6V, V_{DS} = 0V$	-	-	-100	nA
Gate threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 4.4mA$	1.6	-	4.0	V
Static drain - source on - state resistance	$R_{DS(on)}^{*3}$	$V_{GS} = 18V, I_D = 10A$	-	80	117	m Ω
		$T_j = 125^\circ\text{C}$	-	125	-	
Gate input resistance	R_G	$f = 1MHz, \text{open drain}$	-	6.3	-	Ω

●Electrical characteristics (T_a = 25°C)

Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Transconductance	g_{fs}^{*3}	V _{DS} = 10V, I _D = 10A	-	3.7	-	S
Input capacitance	C _{iss}	V _{GS} = 0V	-	2080	-	pF
Output capacitance	C _{oss}	V _{DS} = 800V	-	77	-	
Reverse transfer capacitance	C _{rss}	f = 1MHz	-	16	-	
Effective output capacitance, energy related	C _{o(er)}	V _{GS} = 0V V _{DS} = 0V to 500V	-	116	-	pF
Turn - on delay time	$t_{d(on)}^{*3}$	V _{DD} = 400V, V _{GS} = 18V	-	35	-	ns
Rise time	t_r^{*3}	I _D = 10A	-	36	-	
Turn - off delay time	$t_{d(off)}^{*3}$	R _L = 40Ω	-	76	-	
Fall time	t_f^{*3}	R _G = 0Ω	-	22	-	
Turn - on switching loss	E _{on} ^{*3}	V _{DD} = 600V, I _D =10A V _{GS} = 18V/0V	-	174	-	μJ
Turn - off switching loss	E _{off} ^{*3}	R _G = 0Ω, L=500μH *E _{on} includes diode reverse recovery	-	51	-	

●Gate Charge characteristics (T_a = 25°C)

Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Total gate charge	Q _g ^{*3}	V _{DD} = 400V	-	106	-	nC
Gate - Source charge	Q _{gs} ^{*3}	I _D = 10A	-	27	-	
Gate - Drain charge	Q _{gd} ^{*3}	V _{GS} = 18V	-	31	-	
Gate plateau voltage	V _(plateau)	V _{DD} = 400V, I _D = 10A	-	9.7	-	V

*1 Limited only by maximum temperature allowed.

*2 PW ≤ 10μs, Duty cycle ≤ 1%

*3 Pulsed

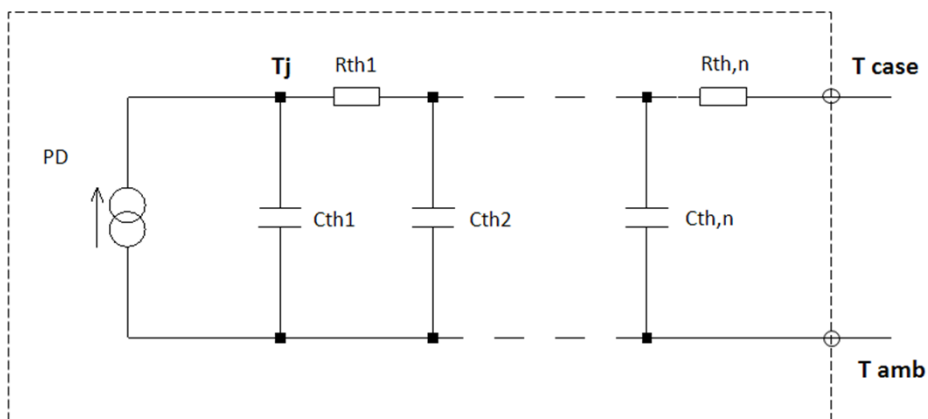
●Body diode electrical characteristics (Source-Drain) ($T_a = 25^\circ\text{C}$)

Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Inverse diode continuous, forward current	I_S^{*1}	$T_C = 25^\circ\text{C}$	-	-	40	A
Inverse diode direct current, pulsed	I_{SM}^{*2}		-	-	80	A
Forward voltage	V_{SD}^{*3}	$V_{GS} = 0\text{V}, I_S = 10\text{A}$	-	4.6	-	V
Reverse recovery time	t_{rr}^{*3}	$I_F = 10\text{A}, V_R = 400\text{V}$ $di/dt = 150\text{A}/\mu\text{s}$	-	31	-	ns
Reverse recovery charge	Q_{rr}^{*3}		-	44	-	nC
Peak reverse recovery current	I_{rrm}^{*3}		-	2.3	-	A

●Typical Transient Thermal Characteristics

Symbol	Value	Unit
R_{th1}	0.078	K/W
R_{th2}	0.197	
R_{th3}	0.162	

Symbol	Value	Unit
C_{th1}	0.005	Ws/K
C_{th2}	0.018	
C_{th3}	0.249	



●Electrical characteristic curves

Fig.1 Power Dissipation Derating Curve

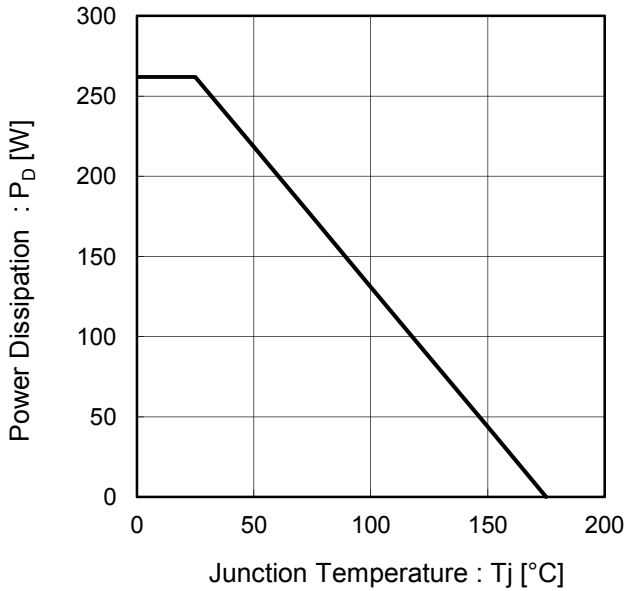


Fig.2 Maximum Safe Operating Area

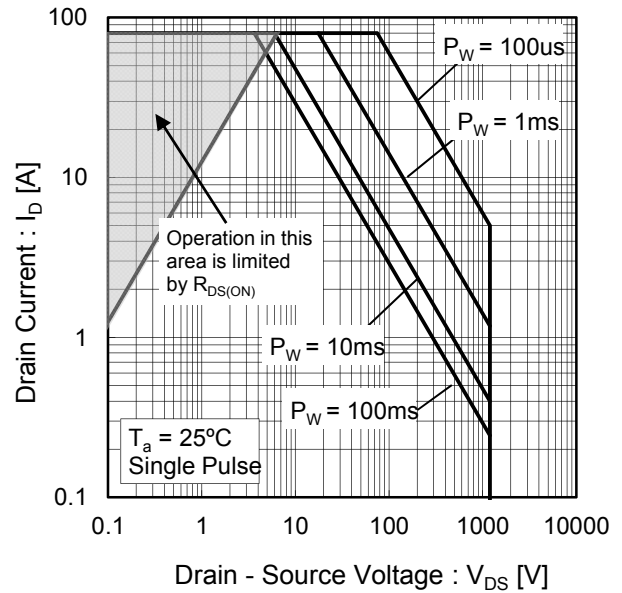
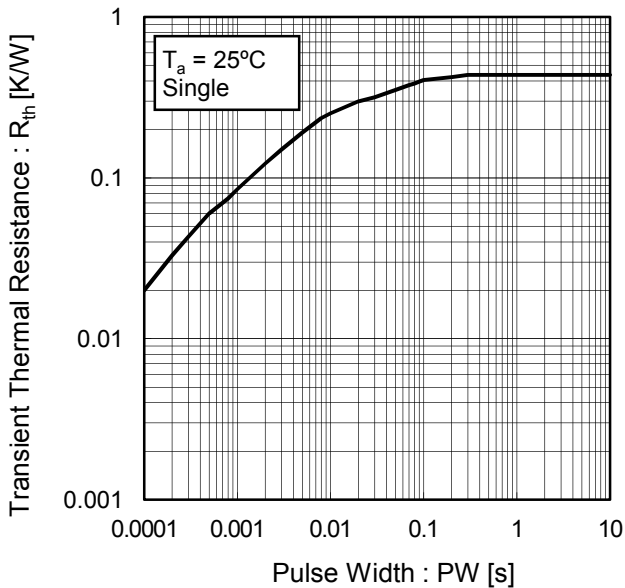


Fig.3 Typical Transient Thermal Resistance vs. Pulse Width



●Electrical characteristic curves

Fig.4 Typical Output Characteristics(I)

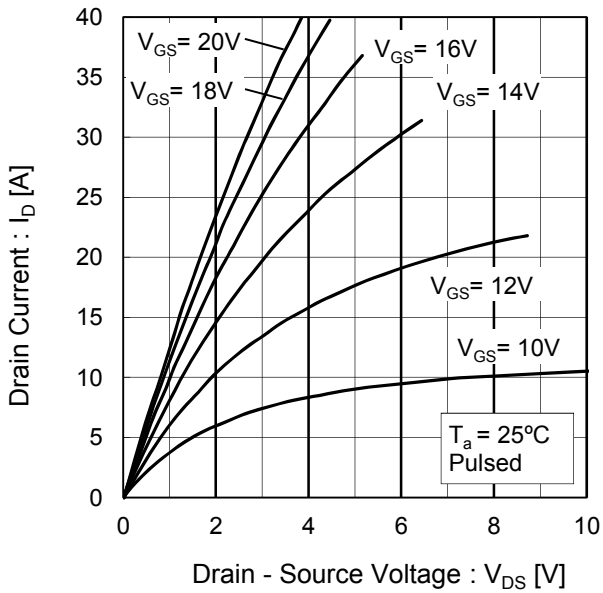


Fig.5 Typical Output Characteristics(II)

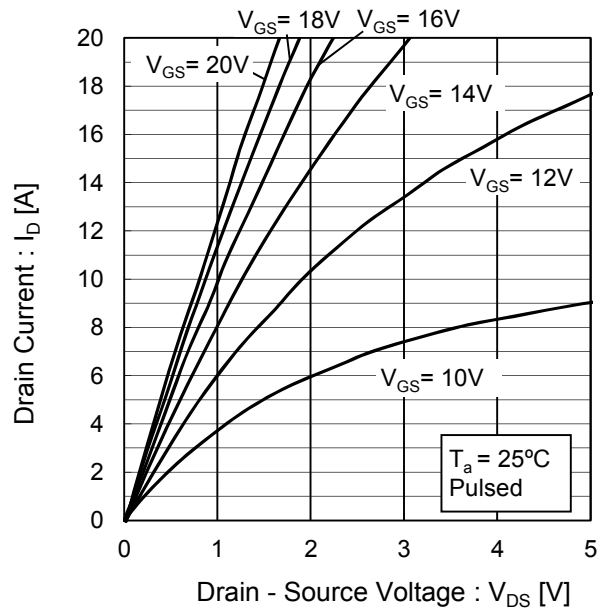


Fig.6 Typical Output Characteristics(I)

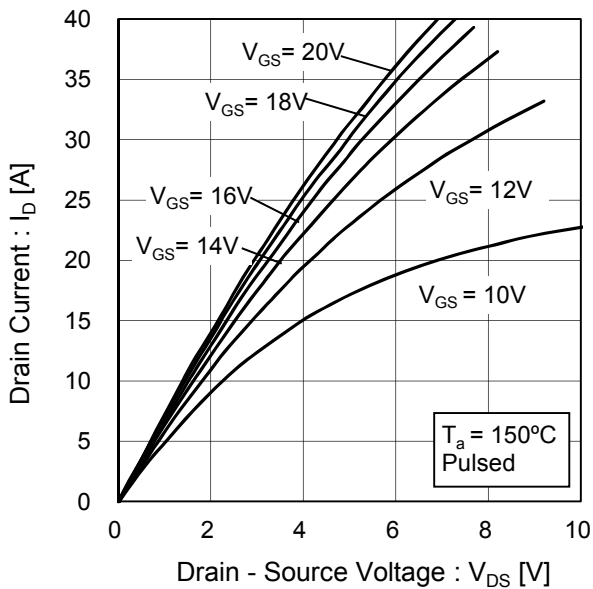
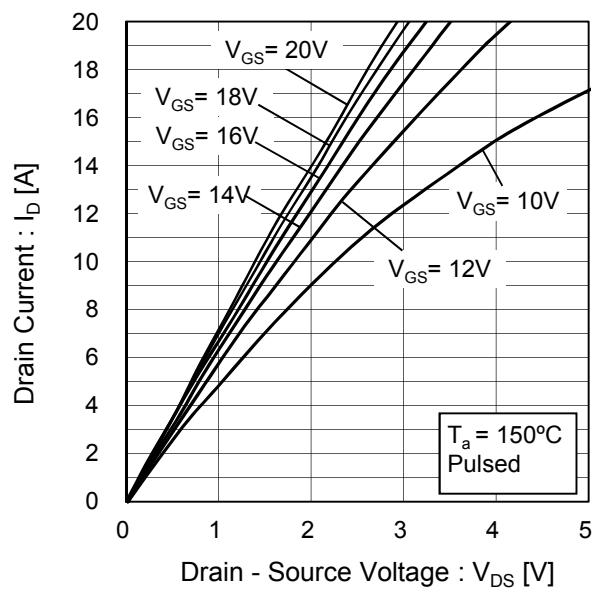


Fig.7 Typical Output Characteristics(II)



●Electrical characteristic curves

Fig.8 Typical Transfer Characteristics

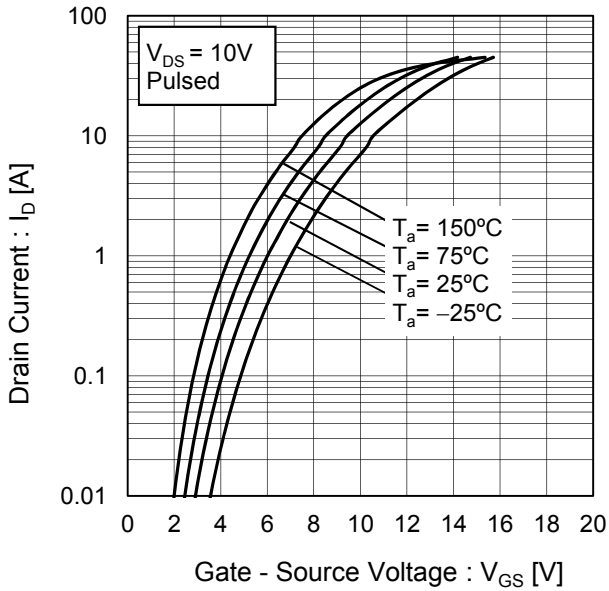


Fig.9 Typical Transfer Characteristics (II)

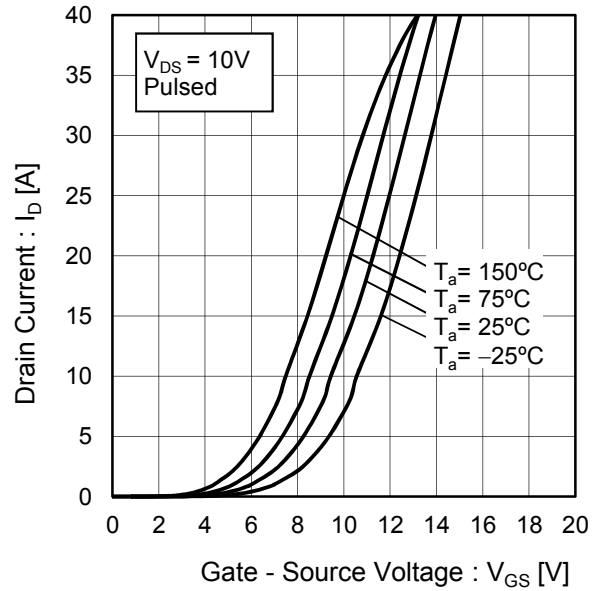


Fig.10 Gate Threshold Voltage vs. Junction Temperature

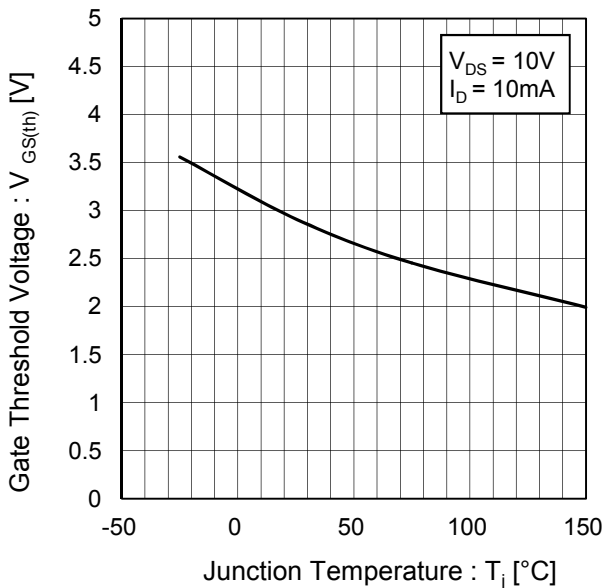
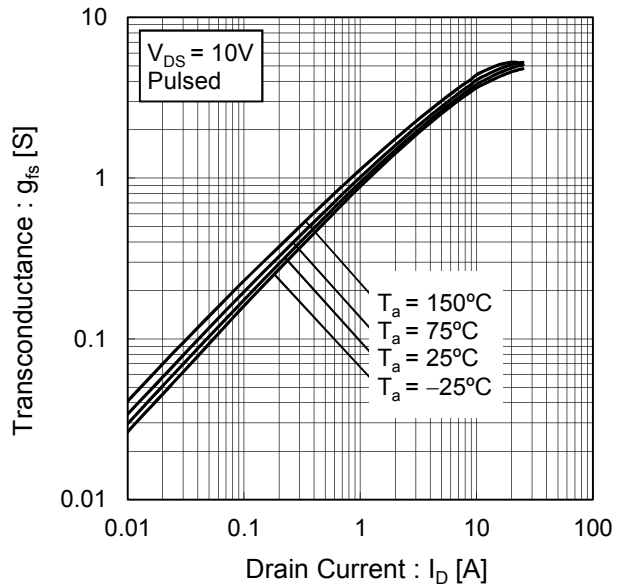


Fig.11 Transconductance vs. Drain Current



●Electrical characteristic curves

Fig.12 Static Drain - Source On - State Resistance vs. Gate - Source Voltage

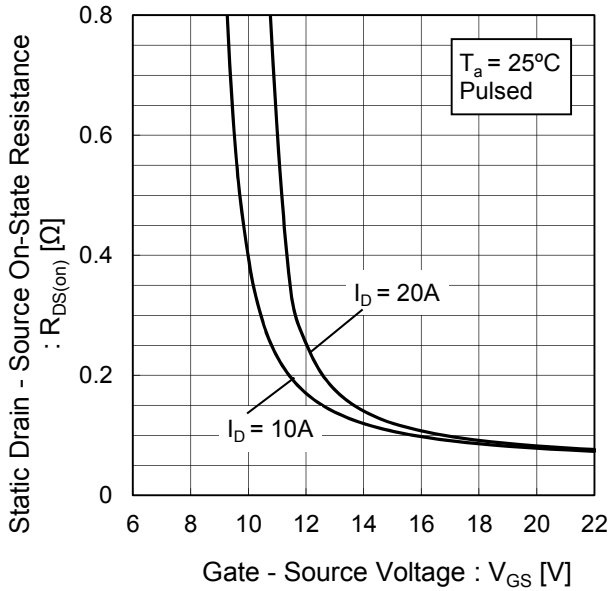


Fig.13 Static Drain - Source On - State Resistance vs. Junction Temperature

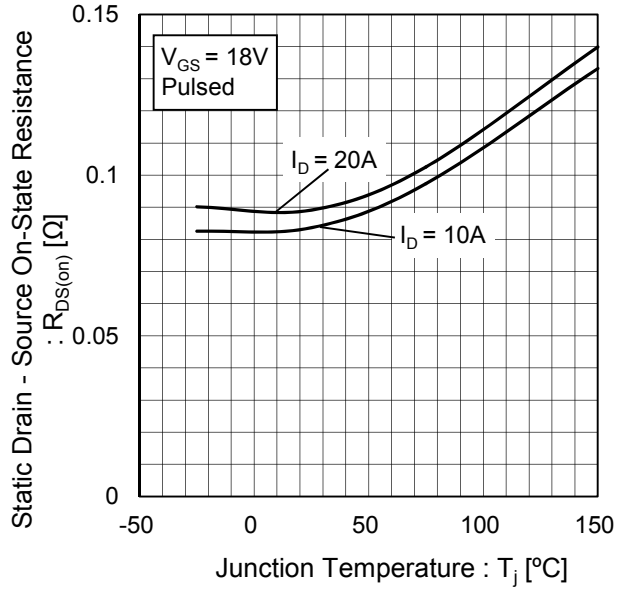
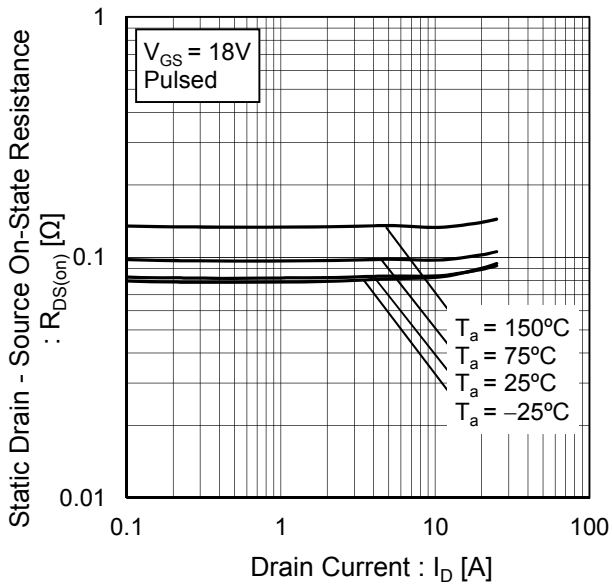


Fig.14 Static Drain - Source On - State Resistance vs. Drain Current



●Electrical characteristic curves

Fig.15 Typical Capacitance vs. Drain - Source Voltage

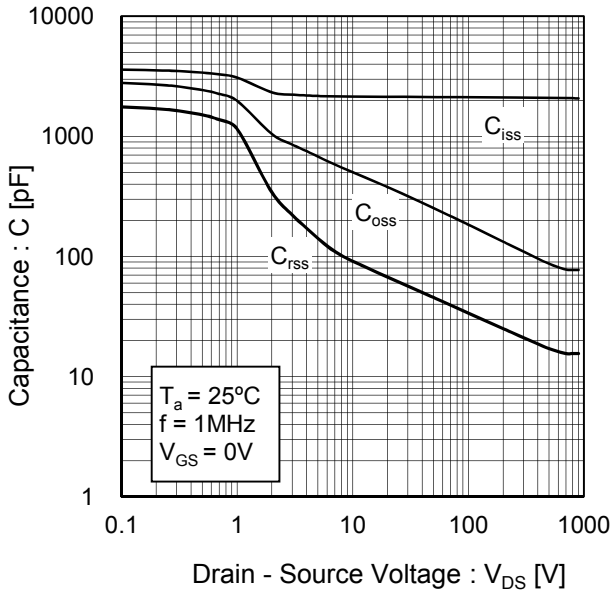


Fig.16 Coss Stored Energy

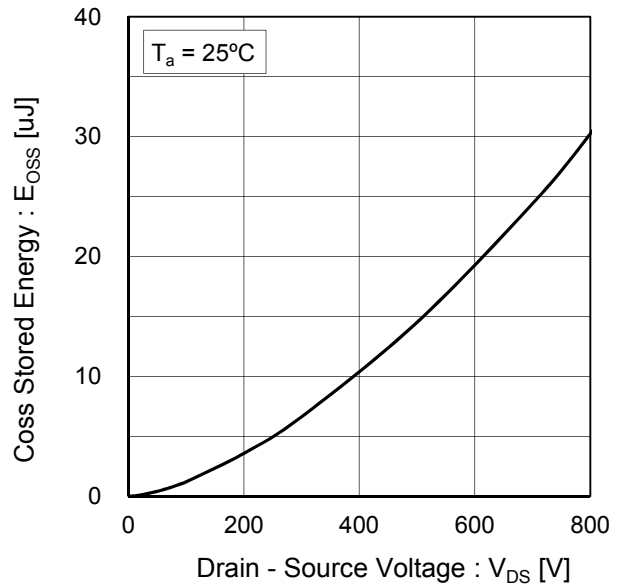


Fig.17 Switching Characteristics

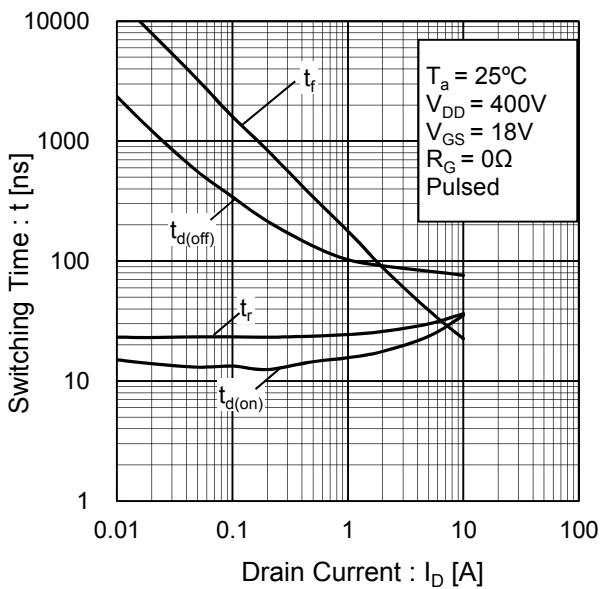
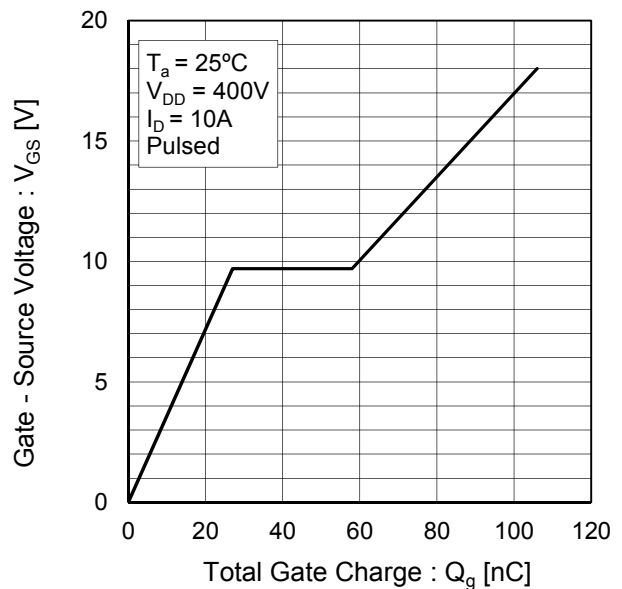


Fig.18 Dynamic Input Characteristics



●Electrical characteristic curves

Fig.19 Typical Switching Loss vs. Drain - Source Voltage

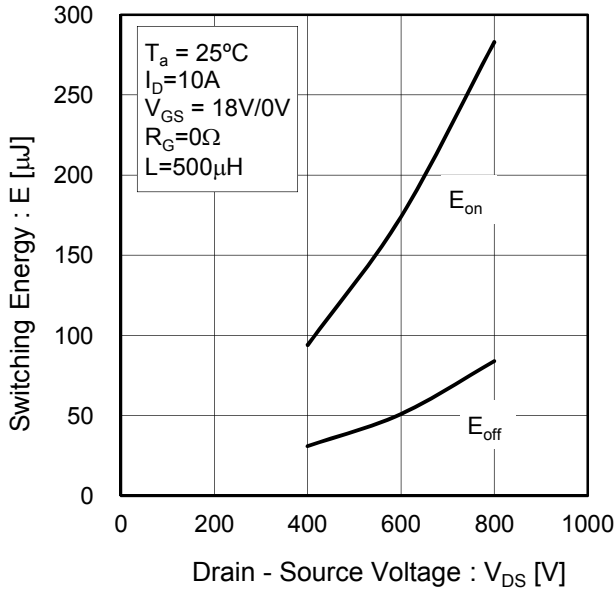


Fig.20 Typical Switching Loss vs. Drain Current

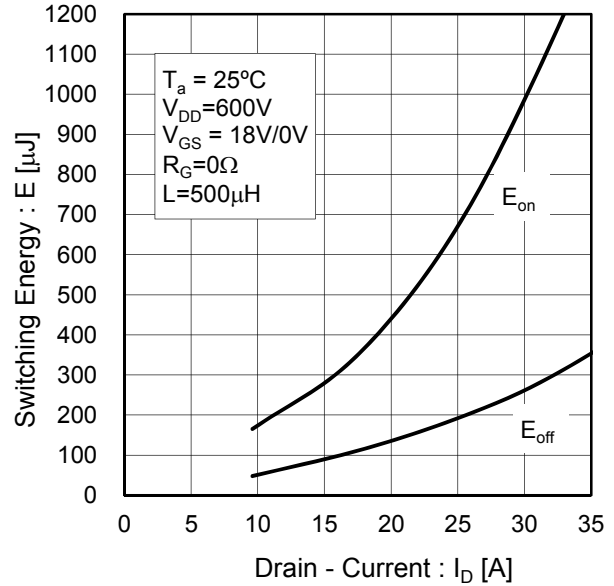
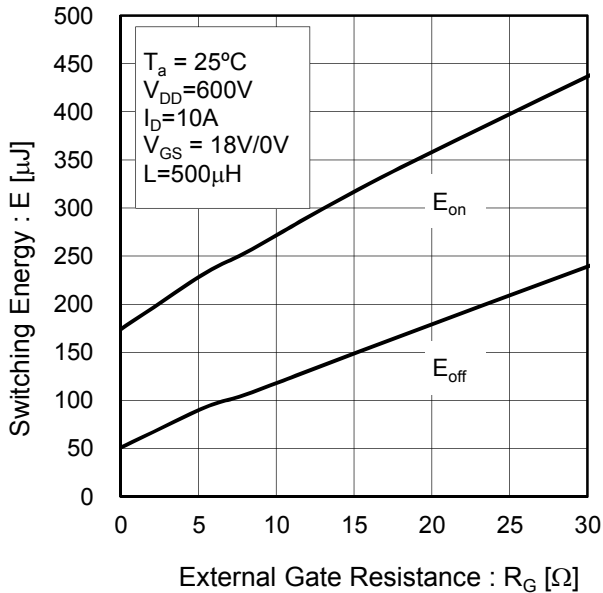


Fig.21 Typical Switching Loss vs. External Gate Resistance



●Electrical characteristic curves

Fig.22 Inverse Diode Forward Current vs. Source - Drain Voltage

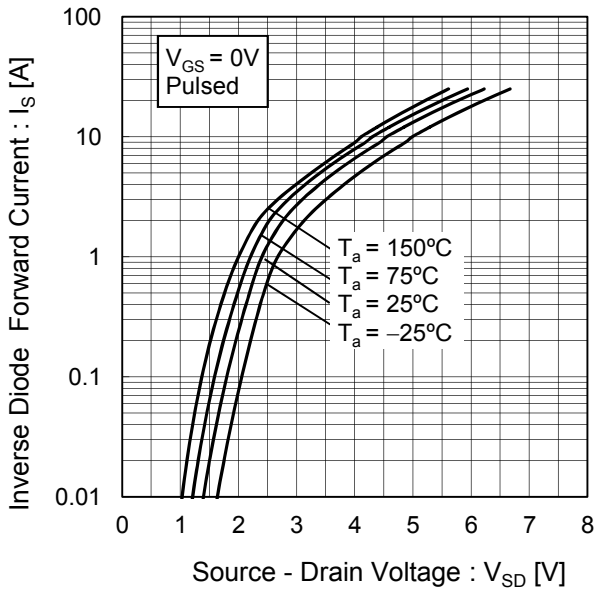
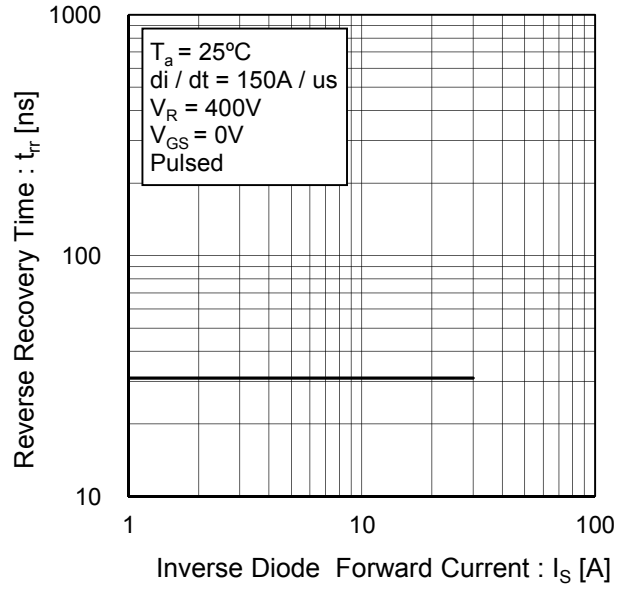


Fig.23 Reverse Recovery Time vs. Inverse Diode Forward Current



●Measurement circuits

Fig.1-1 Switching Time Measurement Circuit



Fig.1-2 Switching Waveforms

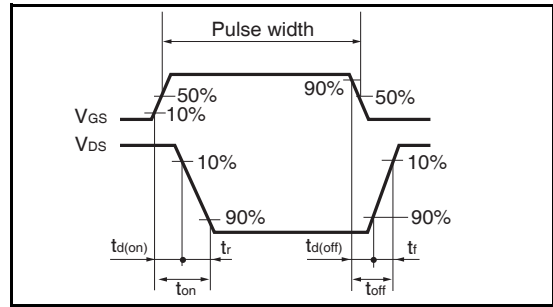


Fig.2-1 Gate Charge Measurement Circuit



Fig.2-2 Gate Charge Waveform

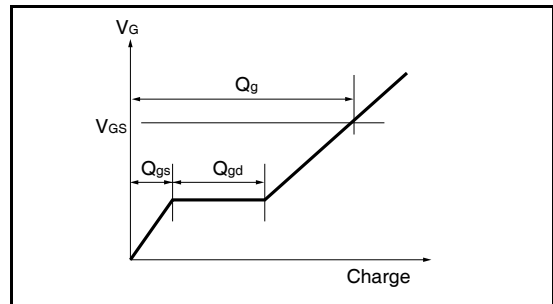


Fig.3-1 Switching Energy Measurement Circuit

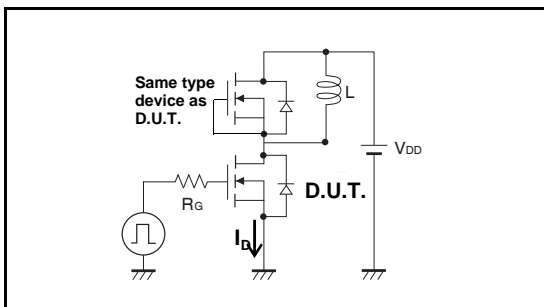


Fig.3-2 Switching Waveforms

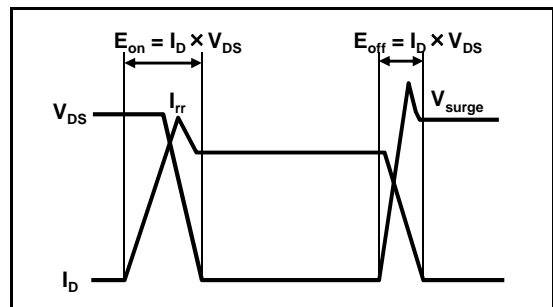


Fig.4-1 Reverse Recovery Time Measurement Circuit

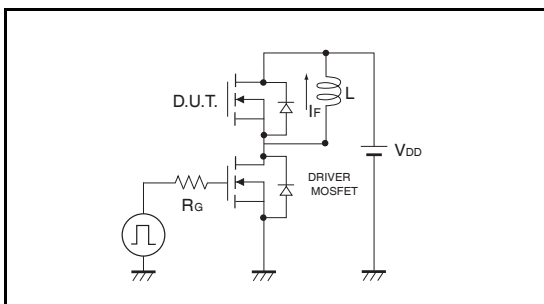
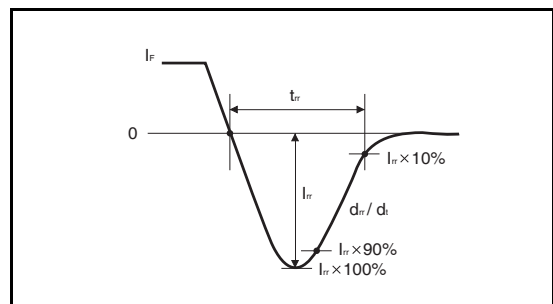
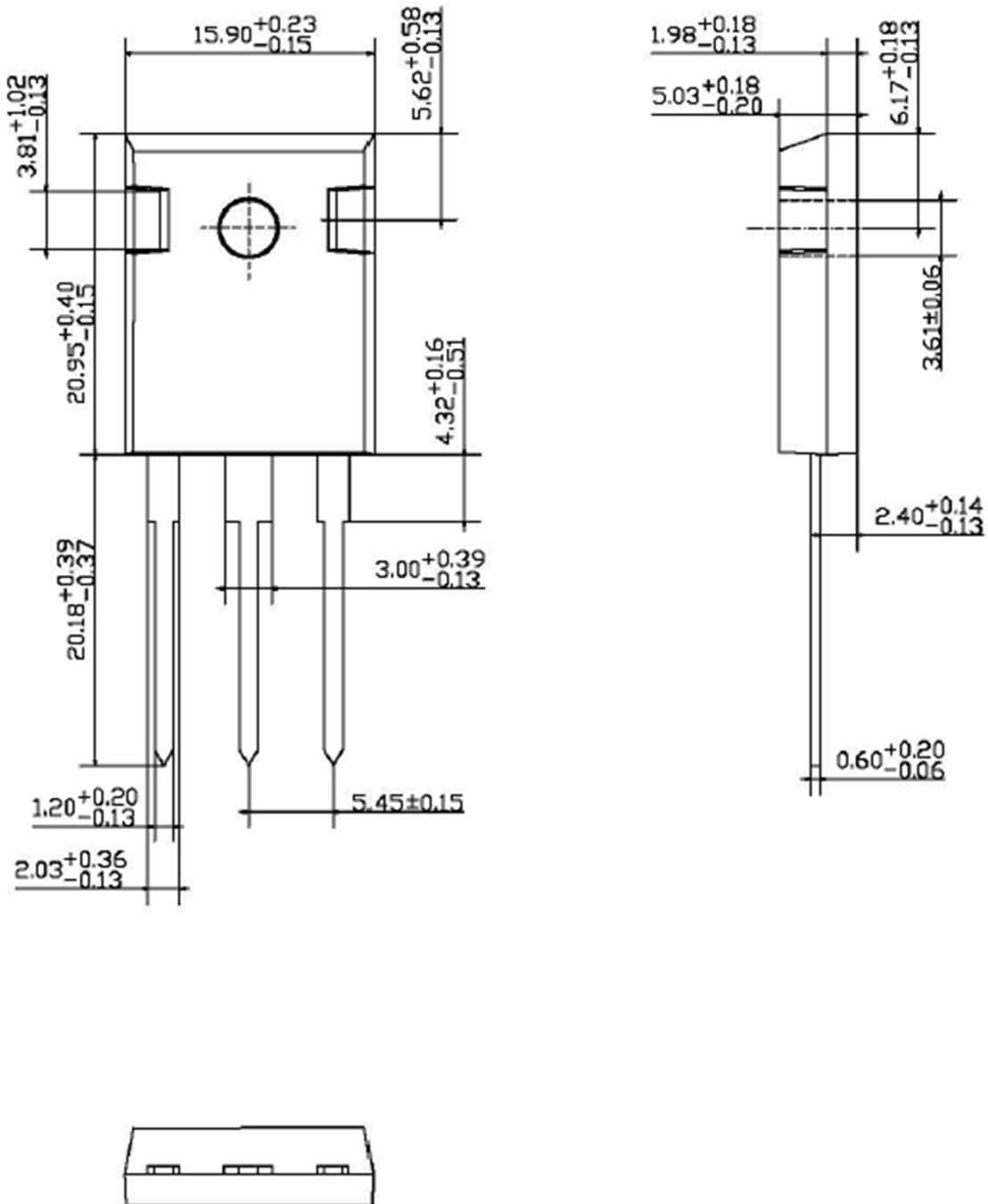


Fig.4-2 Reverse Recovery Waveform



●Dimensions (Unit : mm)

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